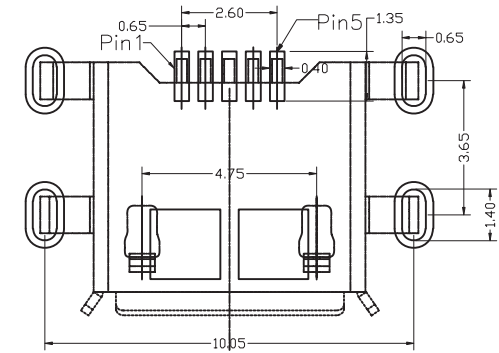
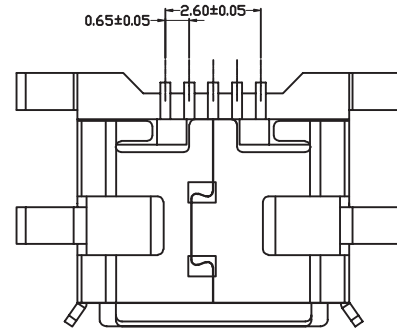
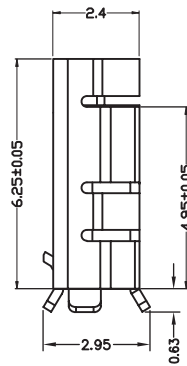
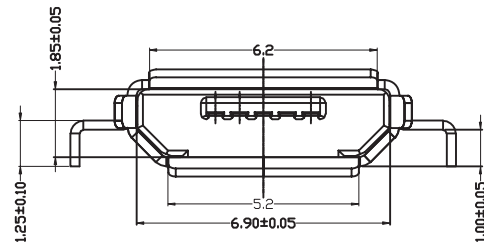
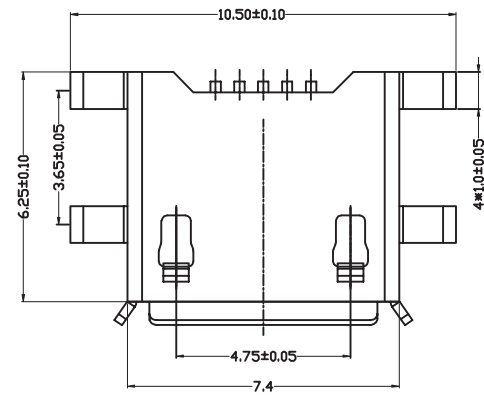
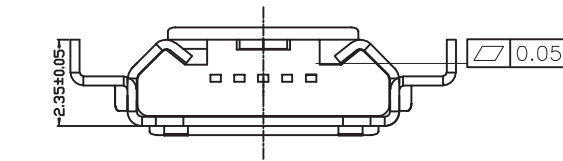


RoHS Compliant



RECOMMENDED PCB LAYOUT

SPECIFICATIONS

- MATERIAL:
 - HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94V-0
 - CONTACT: COPPER ALLOY T=0.15mm
 - SHELL: COPPER ALLOY T=0.25mm
- FINISH:
 - CONTACT:
 - 3u" Min. PLATED ON CONTACT AREA
 - G/F PLATING ON SOLDER TAIL AREA
 - 50~80u" NICKEL UNDERPLATING OVERALL
 - SHELL:
 - 80~120u" MATTTER TIN PLATING ALL
 - 50~80u" NICKEL UNDERPLATING OVERALL
- SPECIFICATION:
 - CURRENT RATING: 1.0A MAX
 - VOLTAGE: 100 VAC
 - TEMPERATURE RANGE: -30 °C ~ 85 °C
 - CONTACT RESISTANCE: 30 MILLIONHM MAX
 - DIELECTRIC WITHSTANDING VOLTAGE: 200 VAC r.m.s
 - INSULATION RESISTNACE: 100 MEGOHMS MIN.

6					PART NAME	MICRO USB JACK	LAKE-VIEW ELECTRONICS CO., LTD.			
5					PART No.	MCU-5F-D4L2				
4					DESIGNER	YAOFEI WANG	VIEW		UNIT	mm
3	SHELL	1	Copper	Ni-Plating	CHECKED BY	DELIANG LIU	VER	1.1	ANGLES	± 1.5°
2	TERMINALS	5	Copper	Ag-Plating	APPROVED BY	David Chen	SHEET	1 OF 1	TOLERANCE	30≤L ± 0.30
1	HOUSING	1	Hi-Temp UL94V-0 Black				DATE	'13.10.22		10≤L≤30 ± 0.25
NO.	DESCRIPTION	QTY	MATERIAL	PLATING						L≤10 ± 0.20